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### **Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems**

**Embedded - System On Chip (SoC)** refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

### **What are Embedded - System On Chip (SoC)?**

**System On Chip (SoC)** integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions, SoCs combine a central

#### **Details**

Product Status	Active
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore™ with CoreSight™
Flash Size	-
RAM Size	64KB
Peripherals	DMA, POR, WDT
Connectivity	CANbus, EBI/EMI, Ethernet, I <sup>2</sup> C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	800MHz
Primary Attributes	FPGA - 85K Logic Elements
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	896-BGA
Supplier Device Package	896-FBGA (31x31)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/5csema5f31c7n">https://www.e-xfl.com/product-detail/intel/5csema5f31c7n</a>



## Recommended Operating Conditions

**Table 4. Recommended Operating Conditions for Cyclone V Devices**

This table lists the steady-state voltage values expected from Cyclone V devices. Power supply ramps must all be strictly monotonic, without plateaus.

Symbol	Description	Condition	Minimum <sup>(2)</sup>	Typical	Maximum <sup>(2)</sup>	Unit
V <sub>CC</sub>	Core voltage, periphery circuitry power supply, transceiver physical coding sublayer (PCS) power supply, and transceiver PCI Express* (PCIe*) hard IP digital power supply	Devices without internal scrubbing feature	1.07	1.1	1.13	V
		Devices with internal scrubbing feature (with SC suffix) <sup>(3)</sup>	1.12	1.15	1.18	V
V <sub>CC_AUX</sub>	Auxiliary supply	—	2.375	2.5	2.625	V
V <sub>CCPD</sub> <sup>(4)</sup>	I/O pre-driver power supply	3.3 V	3.135	3.3	3.465	V
		3.0 V	2.85	3.0	3.15	V
		2.5 V	2.375	2.5	2.625	V
V <sub>CCIO</sub>	I/O buffers power supply	3.3 V	3.135	3.3	3.465	V
		3.0 V	2.85	3.0	3.15	V
		2.5 V	2.375	2.5	2.625	V
		1.8 V	1.71	1.8	1.89	V
		1.5 V	1.425	1.5	1.575	V
		1.35 V	1.283	1.35	1.418	V
		1.25 V	1.19	1.25	1.31	V
		1.2 V	1.14	1.2	1.26	V

*continued...*

- (2) The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.
- (3) The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.
- (4) V<sub>CCPD</sub> must be 2.5 V when V<sub>CCIO</sub> is 2.5, 1.8, 1.5, 1.35, 1.25, or 1.2 V. V<sub>CCPD</sub> must be 3.0 V when V<sub>CCIO</sub> is 3.0 V. V<sub>CCPD</sub> must be 3.3 V when V<sub>CCIO</sub> is 3.3 V.



## Transceiver Power Supply Operating Conditions

**Table 5. Transceiver Power Supply Operating Conditions for Cyclone V GX, GT, SX, and ST Devices**

Symbol	Description	Minimum <sup>(8)</sup>	Typical	Maximum <sup>(8)</sup>	Unit
V <sub>CCH_GXBL</sub>	Transceiver high voltage power (left side)	2.375	2.5	2.625	V
V <sub>CCE_GXBL</sub> <sup>(9)(10)</sup>	Transmitter and receiver power (left side)	1.07/1.17	1.1/1.2	1.13/1.23	V
V <sub>CCL_GXBL</sub> <sup>(9)(10)</sup>	Clock network power (left side)	1.07/1.17	1.1/1.2	1.13/1.23	V

### Related Information

- [PCIe Supported Configurations and Placement Guidelines](#)  
Provides more information about the maximum full duplex channels recommended in Cyclone V GT and ST devices which require full compliance to the PCIe Gen2 transmit jitter specification.
- [6.144-Gbps Support Capability in Cyclone V GT Devices](#)  
Provides more information about the maximum full duplex channels recommended in Cyclone V GT and ST devices for CPRI 6.144 Gbps.

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<sup>(8)</sup> The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

<sup>(9)</sup> Intel recommends increasing the V<sub>CCE\_GXBL</sub> and V<sub>CCL\_GXBL</sub> typical value from 1.1 V to 1.2 V for Cyclone V GT and ST FPGA systems which require full compliance to the PCIe Gen2 transmit jitter specification. For more information about the maximum full duplex channels recommended in Cyclone V GT and ST devices under this condition, refer to the *Transceiver Protocol Configurations in Cyclone V Devices* chapter.

<sup>(10)</sup> Intel recommends increasing the V<sub>CCE\_GXBL</sub> and V<sub>CCL\_GXBL</sub> typical value from 1.1 V to 1.2 V for full compliance to CPRI transmit jitter specification at 4.9152 Gbps (Cyclone V GT and ST devices) and 6.144Gbps (Cyclone V GT and ST devices only). For more information about the maximum full duplex channels recommended in Cyclone V GT and ST devices for CPRI 6.144 Gbps, refer to the *Transceiver Protocol Configurations in Cyclone V Devices* chapter.



**Table 9. OCT Calibration Accuracy Specifications for Cyclone V Devices**

Calibration accuracy for the calibrated on-chip series termination ( $R_S$  OCT) and on-chip parallel termination ( $R_T$  OCT) are applicable at the moment of calibration. When process, voltage, and temperature (PVT) conditions change after calibration, the tolerance may change.

Symbol	Description	Condition (V)	Calibration Accuracy			Unit
			-C6	-I7, -C7	-C8, -A7	
25- $\Omega$ $R_S$	Internal series termination with calibration (25- $\Omega$ setting)	$V_{CCIO} = 3.0, 2.5, 1.8, 1.5, 1.2$	$\pm 15$	$\pm 15$	$\pm 15$	%
50- $\Omega$ $R_S$	Internal series termination with calibration (50- $\Omega$ setting)	$V_{CCIO} = 3.0, 2.5, 1.8, 1.5, 1.2$	$\pm 15$	$\pm 15$	$\pm 15$	%
34- $\Omega$ and 40- $\Omega$ $R_S$	Internal series termination with calibration (34- $\Omega$ and 40- $\Omega$ setting)	$V_{CCIO} = 1.5, 1.35, 1.25, 1.2$	$\pm 15$	$\pm 15$	$\pm 15$	%
48- $\Omega$ , 60- $\Omega$ , and 80- $\Omega$ $R_S$	Internal series termination with calibration (48- $\Omega$ , 60- $\Omega$ , and 80- $\Omega$ setting)	$V_{CCIO} = 1.2$	$\pm 15$	$\pm 15$	$\pm 15$	%
50- $\Omega$ $R_T$	Internal parallel termination with calibration (50- $\Omega$ setting)	$V_{CCIO} = 2.5, 1.8, 1.5, 1.2$	-10 to +40	-10 to +40	-10 to +40	%
20- $\Omega$ , 30- $\Omega$ , 40- $\Omega$ , 60- $\Omega$ , and 120- $\Omega$ $R_T$	Internal parallel termination with calibration (20- $\Omega$ , 30- $\Omega$ , 40- $\Omega$ , 60- $\Omega$ , and 120- $\Omega$ setting)	$V_{CCIO} = 1.5, 1.35, 1.25$	-10 to +40	-10 to +40	-10 to +40	%
60- $\Omega$ and 120- $\Omega$ $R_T$	Internal parallel termination with calibration (60- $\Omega$ and 120- $\Omega$ setting)	$V_{CCIO} = 1.2$	-10 to +40	-10 to +40	-10 to +40	%
25- $\Omega$ $R_{S\_left\_shift}$	Internal left shift series termination with calibration (25- $\Omega$ $R_{S\_left\_shift}$ setting)	$V_{CCIO} = 3.0, 2.5, 1.8, 1.5, 1.2$	$\pm 15$	$\pm 15$	$\pm 15$	%



## Pin Capacitance

**Table 12. Pin Capacitance for Cyclone V Devices**

Symbol	Description	Maximum	Unit
C <sub>IOTB</sub>	Input capacitance on top and bottom I/O pins	6	pF
C <sub>IOLR</sub>	Input capacitance on left and right I/O pins	6	pF
C <sub>OUTFB</sub>	Input capacitance on dual-purpose clock output and feedback pins	6	pF

## Hot Socketing

**Table 13. Hot Socketing Specifications for Cyclone V Devices**

Symbol	Description	Maximum	Unit
I <sub>IOPIN</sub> (DC)	DC current per I/O pin	300	μA
I <sub>IOPIN</sub> (AC)	AC current per I/O pin	8 <sup>(15)</sup>	mA
I <sub>XCVR-TX</sub> (DC)	DC current per transceiver transmitter (TX) pin	100	mA
I <sub>XCVR-RX</sub> (DC)	DC current per transceiver receiver (RX) pin	50	mA

## Internal Weak Pull-Up Resistor

All I/O pins, except configuration, test, and JTAG pins, have an option to enable weak pull-up.

<sup>(15)</sup> The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns,  $|I_{IOPIN}| = C \, dv/dt$ , in which C is the I/O pin capacitance and  $dv/dt$  is the slew rate.



## Single-Ended I/O Standards

**Table 15. Single-Ended I/O Standards for Cyclone V Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>IL</sub> (V)		V <sub>IH</sub> (V)		V <sub>OL</sub> (V)	V <sub>OH</sub> (V)	I <sub>OL</sub> <sup>(18)</sup> (mA)	I <sub>OH</sub> <sup>(18)</sup> (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
3.3-V LVTTTL	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.45	2.4	4	-4
3.3-V LVCMOS	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.2	V <sub>CCIO</sub> - 0.2	2	-2
3.0-V LVTTTL	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.4	2.4	2	-2
3.0-V LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.2	V <sub>CCIO</sub> - 0.2	0.1	-0.1
3.0-V PCI*	2.85	3	3.15	—	0.3 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	V <sub>CCIO</sub> + 0.3	0.1 × V <sub>CCIO</sub>	0.9 × V <sub>CCIO</sub>	1.5	-0.5
3.0-V PCI-X	2.85	3	3.15	—	0.35 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	V <sub>CCIO</sub> + 0.3	0.1 × V <sub>CCIO</sub>	0.9 × V <sub>CCIO</sub>	1.5	-0.5
2.5 V	2.375	2.5	2.625	-0.3	0.7	1.7	3.6	0.4	2	1	-1
1.8 V	1.71	1.8	1.89	-0.3	0.35 × V <sub>CCIO</sub>	0.65 × V <sub>CCIO</sub>	V <sub>CCIO</sub> + 0.3	0.45	V <sub>CCIO</sub> - 0.45	2	-2
1.5 V	1.425	1.5	1.575	-0.3	0.35 × V <sub>CCIO</sub>	0.65 × V <sub>CCIO</sub>	V <sub>CCIO</sub> + 0.3	0.25 × V <sub>CCIO</sub>	0.75 × V <sub>CCIO</sub>	2	-2
1.2 V	1.14	1.2	1.26	-0.3	0.35 × V <sub>CCIO</sub>	0.65 × V <sub>CCIO</sub>	V <sub>CCIO</sub> + 0.3	0.25 × V <sub>CCIO</sub>	0.75 × V <sub>CCIO</sub>	2	-2

## Single-Ended SSTL, HSTL, and HSUL I/O Reference Voltage Specifications

**Table 16. Single-Ended SSTL, HSTL, and HSUL I/O Reference Voltage Specifications for Cyclone V Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>REF</sub> (V)			V <sub>TT</sub> (V)		
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max
SSTL-2 Class I, II	2.375	2.5	2.625	0.49 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.51 × V <sub>CCIO</sub>	V <sub>REF</sub> - 0.04	V <sub>REF</sub>	V <sub>REF</sub> + 0.04
SSTL-18 Class I, II	1.71	1.8	1.89	0.833	0.9	0.969	V <sub>REF</sub> - 0.04	V <sub>REF</sub>	V <sub>REF</sub> + 0.04

*continued...*

<sup>(18)</sup> To meet the I<sub>OL</sub> and I<sub>OH</sub> specifications, you must set the current strength settings accordingly. For example, to meet the 3.3-V LVTTTL specification (4 mA), you should set the current strength settings to 4 mA. Setting at lower current strength may not meet the I<sub>OL</sub> and I<sub>OH</sub> specifications in the datasheet.



## Differential SSTL I/O Standards

**Table 18. Differential SSTL I/O Standards for Cyclone V Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>SWING(DC)</sub> (V)		V <sub>X(AC)</sub> (V)			V <sub>SWING(AC)</sub> (V)	
	Min	Typ	Max	Min	Max	Min	Typ	Max	Min	Max
SSTL-2 Class I, II	2.375	2.5	2.625	0.3	V <sub>CCIO</sub> + 0.6	V <sub>CCIO</sub> /2 - 0.2	—	V <sub>CCIO</sub> /2 + 0.2	0.62	V <sub>CCIO</sub> + 0.6
SSTL-18 Class I, II	1.71	1.8	1.89	0.25	V <sub>CCIO</sub> + 0.6	V <sub>CCIO</sub> /2 - 0.175	—	V <sub>CCIO</sub> /2 + 0.175	0.5	V <sub>CCIO</sub> + 0.6
SSTL-15 Class I, II	1.425	1.5	1.575	0.2	<sup>(20)</sup>	V <sub>CCIO</sub> /2 - 0.15	—	V <sub>CCIO</sub> /2 + 0.15	2(V <sub>IH(AC)</sub> - V <sub>REF</sub> )	2(V <sub>IL(AC)</sub> - V <sub>REF</sub> )
SSTL-135	1.283	1.35	1.45	0.18	<sup>(20)</sup>	V <sub>CCIO</sub> /2 - 0.15	V <sub>CCIO</sub> /2	V <sub>CCIO</sub> /2 + 0.15	2(V <sub>IH(AC)</sub> - V <sub>REF</sub> )	2(V <sub>IL(AC)</sub> - V <sub>REF</sub> )
SSTL-125	1.19	1.25	1.31	0.18	<sup>(20)</sup>	V <sub>CCIO</sub> /2 - 0.15	V <sub>CCIO</sub> /2	V <sub>CCIO</sub> /2 + 0.15	2(V <sub>IH(AC)</sub> - V <sub>REF</sub> )	2(V <sub>IL(AC)</sub> - V <sub>REF</sub> )

## Differential HSTL and HSUL I/O Standards

**Table 19. Differential HSTL and HSUL I/O Standards for Cyclone V Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>DIF(DC)</sub> (V)		V <sub>X(AC)</sub> (V)			V <sub>CM(DC)</sub> (V)			V <sub>DIF(AC)</sub> (V)	
	Min	Typ	Max	Min	Max	Min	Typ	Max	Min	Typ	Max	Min	Max
HSTL-18 Class I, II	1.71	1.8	1.89	0.2	—	0.78	—	1.12	0.78	—	1.12	0.4	—
HSTL-15 Class I, II	1.425	1.5	1.575	0.2	—	0.68	—	0.9	0.68	—	0.9	0.4	—
HSTL-12 Class I, II	1.14	1.2	1.26	0.16	V <sub>CCIO</sub> + 0.3	—	0.5 × V <sub>CCIO</sub>	—	0.4 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.6 × V <sub>CCIO</sub>	0.3	V <sub>CCIO</sub> + 0.48
HSUL-12	1.14	1.2	1.3	0.26	0.26	0.5 × V <sub>CCIO</sub> - 0.12	0.5 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub> + 0.12	0.4 × V <sub>CCIO</sub>	0.5 × V <sub>CCIO</sub>	0.6 × V <sub>CCIO</sub>	0.44	0.44

<sup>(20)</sup> The maximum value for V<sub>SWING(DC)</sub> is not defined. However, each single-ended signal needs to be within the respective single-ended limits (V<sub>IH(DC)</sub> and V<sub>IL(DC)</sub>).



**Table 22. Transceiver Clocks Specifications for Cyclone V GX, GT, SX, and ST Devices**

Symbol/Description	Condition	Transceiver Speed Grade 5 <sup>(30)</sup>			Transceiver Speed Grade 6			Transceiver Speed Grade 7			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
fixedclk clock frequency	PCIe Receiver Detect	—	125	—	—	125	—	—	125	—	MHz
Transceiver Reconfiguration Controller IP (mgmt_clk_clk) clock frequency	—	75	—	100/125 <sup>(37)</sup>	75	—	100/125 <sup>(37)</sup>	75	—	100/125 <sup>(37)</sup>	MHz

**Table 23. Receiver Specifications for Cyclone V GX, GT, SX, and ST Devices**

Symbol/Description	Condition	Transceiver Speed Grade 5 <sup>(30)</sup>			Transceiver Speed Grade 6			Transceiver Speed Grade 7			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Supported I/O standards	1.5 V PCML, 2.5 V PCML, LVPECL, and LVDS										
Data rate <sup>(38)</sup>	—	614	—	5000/6144 <sup>(35)</sup>	614	—	3125	614	—	2500	Mbps
Absolute V <sub>MAX</sub> for a receiver pin <sup>(39)</sup>	—	—	—	1.2	—	—	1.2	—	—	1.2	V
Absolute V <sub>MIN</sub> for a receiver pin	—	-0.4	—	—	-0.4	—	—	-0.4	—	—	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p) before device configuration	—	—	—	1.6	—	—	1.6	—	—	1.6	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p) after device configuration	—	—	—	2.2	—	—	2.2	—	—	2.2	V

*continued...*

- (37) The maximum supported clock frequency is 100 MHz if the PCIe hard IP block is enabled or 125 MHz if the PCIe hard IP block is not enabled.
- (38) To support data rates lower than the minimum specification through oversampling, use the CDR in LTR mode only.
- (39) The device cannot tolerate prolonged operation at this absolute maximum.



Symbol/Description	Condition	Transceiver Speed Grade 5 <sup>(30)</sup>			Transceiver Speed Grade 6			Transceiver Speed Grade 7			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Intra-differential pair skew	TX $V_{CM}$ = 0.65 V and slew rate of 15 ps	—	—	15	—	—	15	—	—	15	ps
Intra-transceiver block transmitter channel-to-channel skew	×6 PMA bonded mode	—	—	180	—	—	180	—	—	180	ps
Inter-transceiver block transmitter channel-to-channel skew	×N PMA bonded mode	—	—	500	—	—	500	—	—	500	ps

**Table 25. CMU PLL Specifications for Cyclone V GX, GT, SX, and ST Devices**

Symbol/Description	Condition	Transceiver Speed Grade 5 <sup>(30)</sup>			Transceiver Speed Grade 6			Transceiver Speed Grade 7			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Supported data range	—	614	—	5000/6144 <sup>(35)</sup>	614	—	3125	614	—	2500	Mbps
fPLL supported data range	—	614	—	3125	614	—	3125	614	—	2500	Mbps

**Table 26. Transceiver-FPGA Fabric Interface Specifications for Cyclone V GX, GT, SX, and ST Devices**

Symbol/Description	Condition	Transceiver Speed Grade 5 <sup>(30)</sup>			Transceiver Speed Grade 6			Transceiver Speed Grade 7			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Interface speed (single-width mode)	—	25	—	187.5	25	—	187.5	25	—	163.84	MHz
Interface speed (double-width mode)	—	25	—	163.84	25	—	163.84	25	—	156.25	MHz

**Related Information**

- [CTLE Response at Data Rates > 3.25 Gbps across Supported AC Gain and DC Gain](#) on page 32
- [CTLE Response at Data Rates ≤ 3.25 Gbps across Supported AC Gain and DC Gain](#) on page 33
- [PCIe Supported Configurations and Placement Guidelines](#)  
Provides more information about the maximum full duplex channels recommended in Cyclone V GT and ST devices which require full compliance to the PCIe Gen2 transmit jitter specification.



Typical TX  $V_{OD}$  Setting for Cyclone V Transceiver Channels with termination of 100  $\Omega$

Table 27. Typical TX  $V_{OD}$  Setting for Cyclone V Transceiver Channels with termination of 100  $\Omega$

Symbol	$V_{OD}$ Setting <sup>(48)</sup>	$V_{OD}$ Value (mV)	$V_{OD}$ Setting <sup>(48)</sup>	$V_{OD}$ Value (mV)
V <sub>OD</sub> differential peak-to-peak typical	6 <sup>(49)</sup>	120	34	680
	7 <sup>(49)</sup>	140	35	700
	8 <sup>(49)</sup>	160	36	720
	9	180	37	740
	10	200	38	760
	11	220	39	780
	12	240	40	800
	13	260	41	820
	14	280	42	840
	15	300	43	860
	16	320	44	880
	17	340	45	900
	18	360	46	920
	19	380	47	940
	20	400	48	960
	21	420	49	980
	22	440	50	1000
23	460	51	1020	
24	480	52	1040	

*continued...*

<sup>(48)</sup> Convert these values to their binary equivalent form if you are using the dynamic reconfiguration mode for PMA analog controls.

<sup>(49)</sup> Only valid for data rates  $\leq$  5 Gbps.



Symbol	Parameter	Condition	Min	Typ	Max	Unit
		-C8, -A7 speed grades	600	—	1300	MHz
t <sub>EINDUTY</sub>	Input clock or external feedback clock input duty cycle	—	40	—	60	%
f <sub>OUT</sub>	Output frequency for internal global or regional clock	-C6, -C7, -I7 speed grades	—	—	550 <sup>(54)</sup>	MHz
		-C8, -A7 speed grades	—	—	460 <sup>(54)</sup>	MHz
f <sub>OUT_EXT</sub>	Output frequency for external clock output	-C6, -C7, -I7 speed grades	—	—	667 <sup>(54)</sup>	MHz
		-C8, -A7 speed grades	—	—	533 <sup>(54)</sup>	MHz
t <sub>OUTDUTY</sub>	Duty cycle for external clock output (when set to 50%)	—	45	50	55	%
t <sub>FCOMP</sub>	External feedback clock compensation time	—	—	—	10	ns
t <sub>DYCONFIGCLK</sub>	Dynamic configuration clock for <code>mgmt_clk</code> and <code>scanclk</code>	—	—	—	100	MHz
t <sub>LOCK</sub>	Time required to lock from end-of-device configuration or deassertion of <code>areset</code>	—	—	—	1	ms
t <sub>DLOCK</sub>	Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays)	—	—	—	1	ms
f <sub>CLBW</sub>	PLL closed-loop bandwidth	Low	—	0.3	—	MHz
		Medium	—	1.5	—	MHz
		High <sup>(55)</sup>	—	4	—	MHz
t <sub>PLL_PSERR</sub>	Accuracy of PLL phase shift	—	—	—	±50	ps

*continued...*

- (53) The VCO frequency reported by the Intel Quartus Prime software takes into consideration the VCO post-scale counter  $K$  value. Therefore, if the counter  $K$  has a value of 2, the frequency reported can be lower than the  $f_{VCO}$  specification.
- (54) This specification is limited by the lower of the two:  $I/O f_{MAX}$  or  $F_{OUT}$  of the PLL.
- (55) High bandwidth PLL settings are not supported in external feedback mode.



Symbol	Parameter	Condition	Min	Typ	Max	Unit
t <sub>OUTCCJ_IO</sub> <sup>(58)(60)</sup>	Cycle-to-cycle jitter for clock output on regular I/O in integer PLL	F <sub>OUT</sub> < 100 MHz	—	—	65	mUI (p-p)
		F <sub>OUT</sub> ≥ 100 MHz	—	—	650	ps (p-p)
		F <sub>OUT</sub> < 100 MHz	—	—	65	mUI (p-p)
t <sub>FOUTCCJ_IO</sub> <sup>(58)(60)(61)</sup>	Cycle-to-cycle jitter for clock output on regular I/O in fractional PLL	F <sub>OUT</sub> ≥ 100 MHz	—	—	650	ps (p-p)
		F <sub>OUT</sub> < 100 MHz	—	—	65	mUI (p-p)
t <sub>CASC_OUTPJ_DC</sub> <sup>(58)(62)</sup>	Period jitter for dedicated clock output in cascaded PLLs	F <sub>OUT</sub> ≥ 100 MHz	—	—	300	ps (p-p)
		F <sub>OUT</sub> < 100 MHz	—	—	30	mUI (p-p)
t <sub>DRIFT</sub>	Frequency drift after PFDENA is disabled for a duration of 100 μs	—	—	—	±10	%
dK <sub>BIT</sub>	Bit number of Delta Sigma Modulator (DSM)	—	8	24	32	Bits
k <sub>VALUE</sub>	Numerator of fraction	—	128	8388608	2147483648	—
f <sub>RES</sub>	Resolution of VCO frequency	f <sub>INPFD</sub> = 100 MHz	390625	5.96	0.023	Hz

### Related Information

[Memory Output Clock Jitter Specifications](#) on page 49

Provides more information about the external memory interface clock output jitter specifications.

(61) This specification only covers fractional PLL for low bandwidth. The f<sub>VCO</sub> for fractional value range 0.05–0.95 must be ≥ 1000 MHz.

(62) The cascaded PLL specification is only applicable with the following conditions:

- Upstream PLL: 0.59 MHz ≤ Upstream PLL BW < 1 MHz
- Downstream PLL: Downstream PLL BW > 2 MHz



Symbol	Condition	-C6			-C7, -I7			-C8, -A7			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
	SERDES factor J = 1 to 2, uses DDR registers	(65)	—	(66)	(65)	—	(66)	(65)	—	(66)	Mbps
	Emulated Differential I/O Standards with Three External Output Resistor Networks- $f_{HSDR}$ (data rate) <sup>(67)</sup>	(65)	—	640	(65)	—	640	(65)	—	550	Mbps
	Emulated Differential I/O Standards with One External Output Resistor Network - $f_{HSDR}$ (data rate)	(65)	—	170	(65)	—	170	(65)	—	170	Mbps
$t_{x \text{ Jitter}}$ -True Differential I/O Standards <sup>(67)</sup>	Total Jitter for Data Rate, 600 Mbps – 840 Mbps	—	—	350	—	—	380	—	—	500	ps
	Total Jitter for Data Rate < 600Mbps	—	—	0.21	—	—	0.23	—	—	0.30	UI
$t_{x \text{ Jitter}}$ -Emulated Differential I/O Standards with Three External Output Resistor Networks	Total Jitter for Data Rate < 640Mbps	—	—	500	—	—	500	—	—	500	ps
$t_{x \text{ Jitter}}$ -Emulated Differential I/O Standards with One External Output Resistor Network	Total Jitter for Data Rate < 640Mbps	—	—	0.15	—	—	0.15	—	—	0.15	UI
$t_{DUTY}$	TX output clock duty cycle for both True and	45	50	55	45	50	55	45	50	55	%

continued...

<sup>(66)</sup> The maximum ideal data rate is the SERDES factor (J) × PLL max output frequency ( $f_{out}$ ), provided you can close the design timing and the signal integrity simulation is clean. You can estimate the achievable maximum data rate by performing link timing closure analysis. You must consider the board skew margin, transmitter delay margin, and receiver sampling margin to determine the maximum data rate supported.

<sup>(67)</sup> You must calculate the leftover timing margin in the receiver by performing link timing closure analysis. You must consider the board skew margin, transmitter channel-to-channel skew, and receiver sampling margin to determine the leftover timing margin.



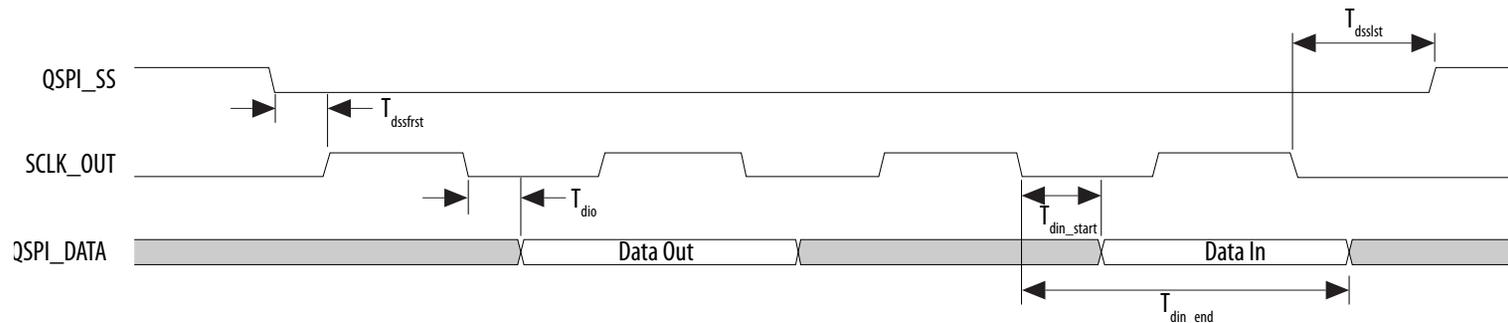
## Quad SPI Flash Timing Characteristics

**Table 43. Quad Serial Peripheral Interface (SPI) Flash Timing Requirements for Cyclone V Devices**

Symbol	Description	Min	Typ	Max	Unit
$F_{clk}$	SCLK_OUT clock frequency (External clock)	—	—	108	MHz
$T_{qspi\_clk}$	QSPI_CLK clock period (Internal reference clock)	2.32	—	—	ns
$T_{dutycycle}$	SCLK_OUT duty cycle	45	—	55	%
$T_{dssfrst}$	Output delay QSPI_SS valid before first clock edge	—	1/2 cycle of SCLK_OUT	—	ns
$T_{dsslst}$	Output delay QSPI_SS valid after last clock edge	-1	—	1	ns
$T_{dio}$	I/O data output delay	-1	—	1	ns
$T_{din\_start}$	Input data valid start	—	—	$(2 + R_{delay}) \times T_{qspi\_clk} - 7.52$ <sup>(68)</sup>	ns
$T_{din\_end}$	Input data valid end	$(2 + R_{delay}) \times T_{qspi\_clk} - 1.21$ <sup>(68)</sup>	—	—	ns

**Figure 6. Quad SPI Flash Timing Diagram**

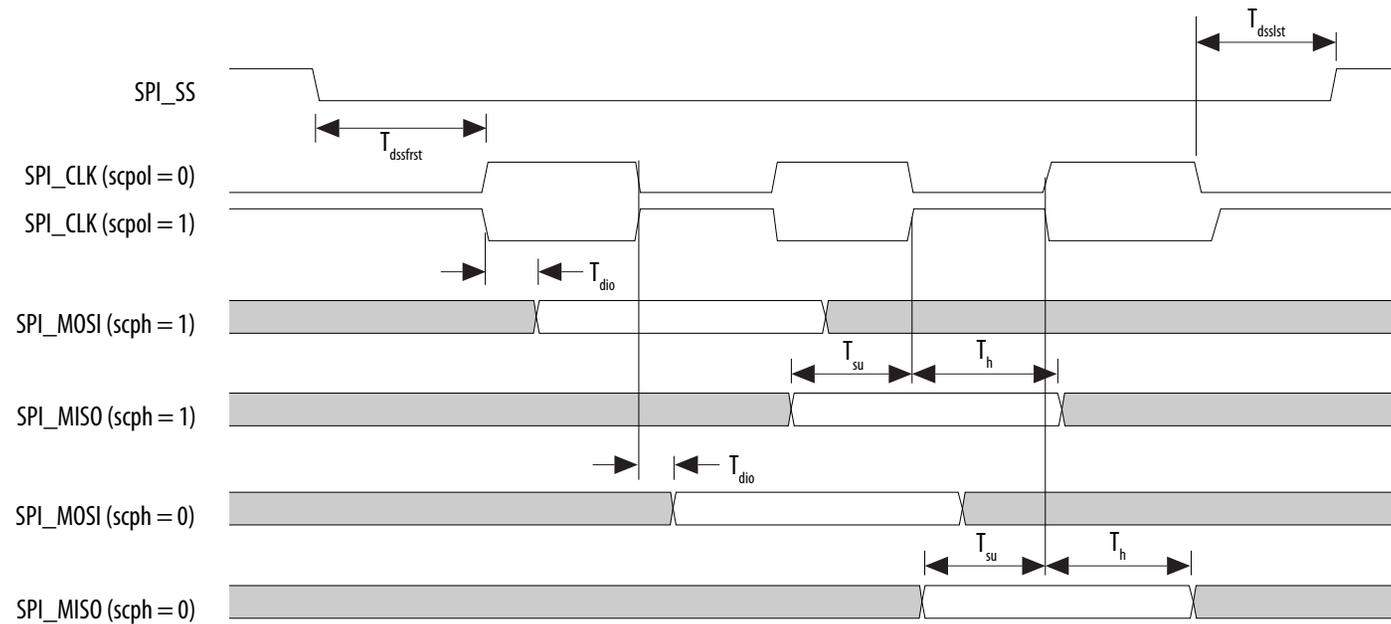
This timing diagram illustrates clock polarity mode 0 and clock phase mode 0.



<sup>(68)</sup>  $R_{delay}$  is set by programming the register `qspiregs.rddatacap`. For the SoC EDS software version 13.1 and later, Intel provides automatic Quad SPI calibration in the preloader. For more information about  $R_{delay}$ , refer to the *Quad SPI Flash Controller* chapter in the *Cyclone V Hard Processor System Technical Reference Manual*.



**Figure 7. SPI Master Timing Diagram**



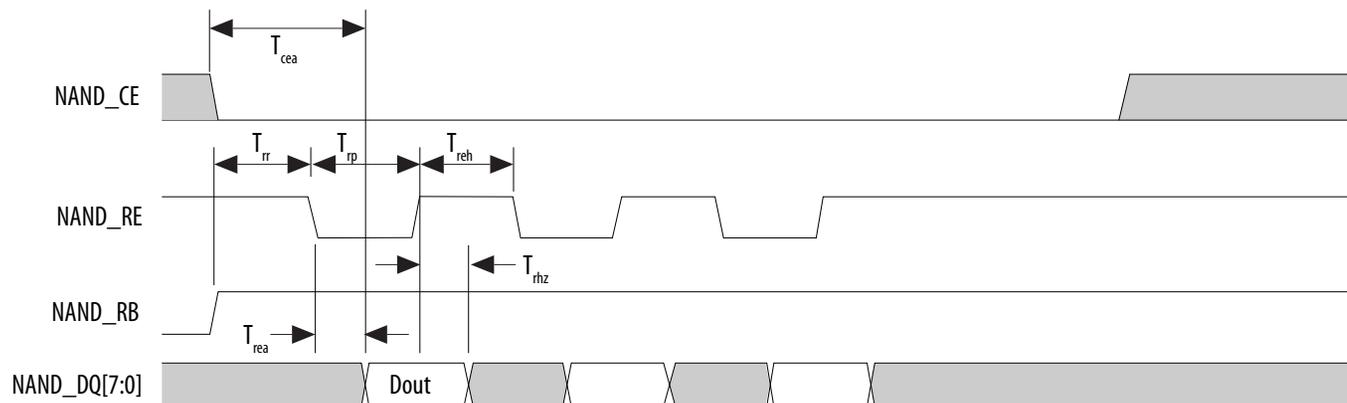
**Table 45. SPI Slave Timing Requirements for Cyclone V Devices**

The setup and hold times can be used for Texas Instruments SSP mode and National Semiconductor Microwire mode.

Symbol	Description	Min	Max	Unit
$T_{clk}$	CLK clock period	20	—	ns
$T_s$	MOSI Setup time	5	—	ns
$T_h$	MOSI Hold time	5	—	ns
$T_{suss}$	Setup time SPI_SS valid before first clock edge	8	—	ns
$T_{hss}$	Hold time SPI_SS valid after last clock edge	8	—	ns
$T_d$	MISO output delay	—	6	ns



Figure 18. NAND Data Read Timing Diagram



## Arm Trace Timing Characteristics

Table 53. Arm Trace Timing Requirements for Cyclone V Devices

Most debugging tools have a mechanism to adjust the capture point of trace data.

Description	Min	Max	Unit
CLK clock period	12.5	—	ns
CLK maximum duty cycle	45	55	%
CLK to D0 –D7 output data delay	–1	1	ns

## UART Interface

The maximum UART baud rate is 6.25 megasymbols per second.

## GPIO Interface

The minimum detectable general-purpose I/O (GPIO) pulse width is 2  $\mu$ s. The pulse width is based on a debounce clock frequency of 1 MHz.

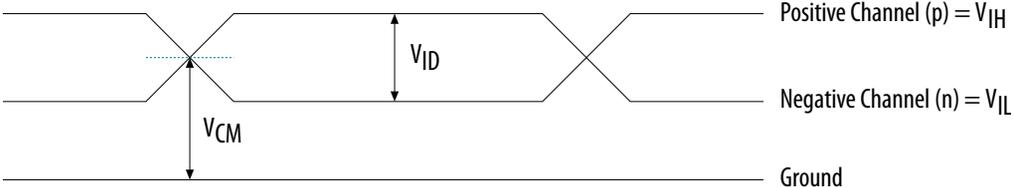


Variant	Member Code	Active Serial <sup>(96)</sup>			Fast Passive Parallel <sup>(97)</sup>		
		Width	DCLK (MHz)	Minimum Configuration Time (ms)	Width	DCLK (MHz)	Minimum Configuration Time (ms)
Cyclone V GX	A9	4	100	257	16	125	51
	C3	4	100	36	16	125	7
	C4	4	100	85	16	125	17
	C5	4	100	85	16	125	17
	C7	4	100	140	16	125	28
Cyclone V GT	C9	4	100	257	16	125	51
	D5	4	100	85	16	125	17
	D7	4	100	140	16	125	28
Cyclone V SE	D9	4	100	257	16	125	51
	A2	4	100	85	16	125	17
	A4	4	100	85	16	125	17
	A5	4	100	140	16	125	28
Cyclone V SX	A6	4	100	140	16	125	28
	C2	4	100	85	16	125	17
	C4	4	100	85	16	125	17
	C5	4	100	140	16	125	28
Cyclone V ST	C6	4	100	140	16	125	28
	D5	4	100	140	16	125	28
	D6	4	100	140	16	125	28

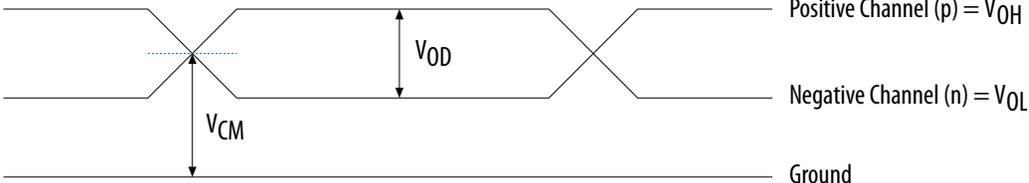
<sup>(96)</sup> DCLK frequency of 100 MHz using external CLKUSR.

<sup>(97)</sup> Maximum FPGA FPP bandwidth may exceed bandwidth available from some external storage or control logic.



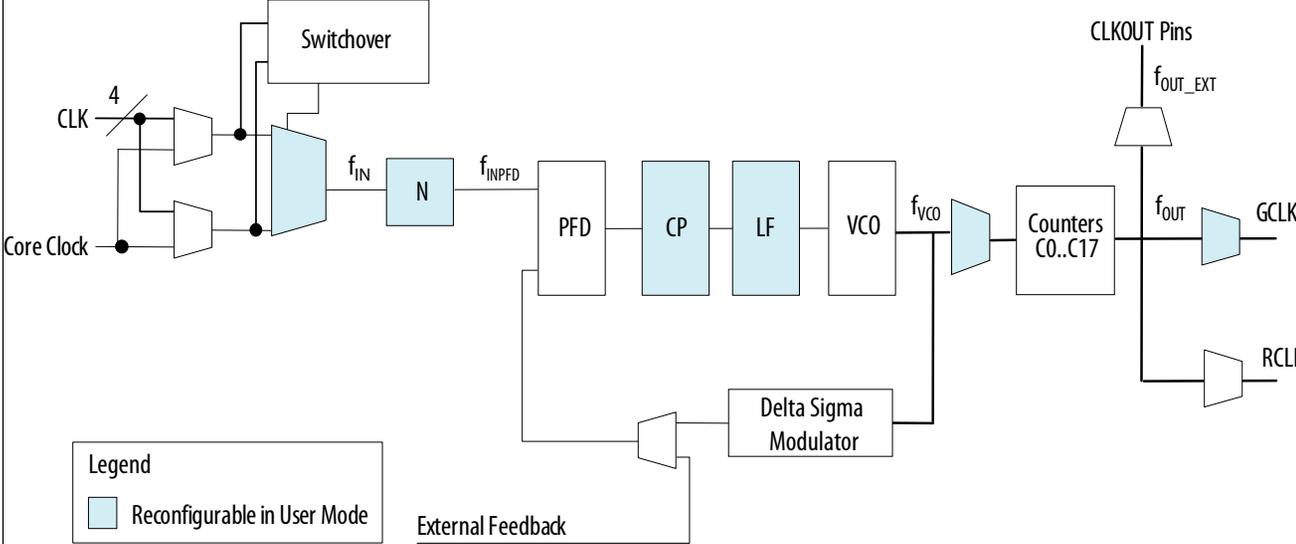
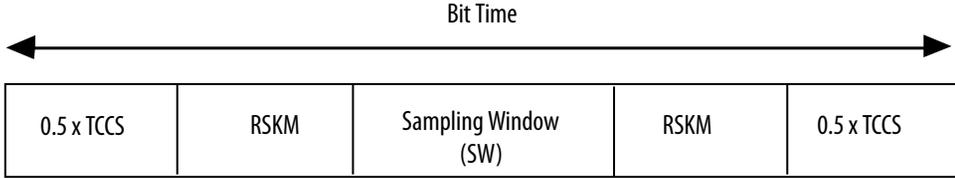
Term	Definition
	<p data-bbox="730 316 970 344"><b>Single-Ended Waveform</b></p>  <p data-bbox="1507 365 1743 393">Positive Channel (p) = <math>V_{IH}</math></p> <p data-bbox="1507 446 1743 474">Negative Channel (n) = <math>V_{IL}</math></p> <p data-bbox="1507 527 1575 555">Ground</p> <p data-bbox="730 609 955 636"><b>Differential Waveform</b></p>  <p data-bbox="1507 730 1596 758"><math>p - n = 0V</math></p> <p data-bbox="592 860 886 888">Transmitter Output Waveforms</p> <p data-bbox="1738 917 1869 945"><i>continued...</i></p>



Term	Definition
	<p><b>Single-Ended Waveform</b></p>  <p>Positive Channel (p) = <math>V_{OH}</math>              Negative Channel (n) = <math>V_{OL}</math>              Ground</p> <p><b>Differential Waveform</b></p>  <p><math>p - n = 0\text{ V}</math></p>
$f_{HSCLK}$	Left/right PLL input clock frequency.
$f_{HSDR}$	High-speed I/O block—Maximum/minimum LVDS data transfer rate ( $f_{HSDR} = 1/TUI$ ).
J	High-speed I/O block—Deserialization factor (width of parallel data bus).
JTAG timing specifications	JTAG Timing Specifications

*continued...*



Term	Definition
	 <p>The diagram illustrates the PLL architecture. It starts with a 'Core Clock' input that branches into a '4' divider and a 'Switchover' block. The 'Switchover' block selects between the divided core clock and an external 'External Feedback' signal. The selected signal, labeled <math>f_{IN}</math>, passes through a divider 'N' to become <math>f_{INPFD}</math>. This signal then goes through a 'PFD' (Phase-Frequency Detector), a 'CP' (Charge Pump), a 'LF' (Loop Filter), and a 'VCO' (Voltage-Controlled Oscillator) to produce <math>f_{VCO}</math>. The <math>f_{VCO}</math> signal is then divided by a 'Counters CO..C17' block to produce <math>f_{OUT}</math>. This output is available at 'CLKOUT Pins' as <math>f_{OUT\_EXT}</math> and also passes through a divider to become 'RCLK'. A 'Delta Sigma Modulator' is connected to the feedback path between the PFD and the VCO.</p> <p><b>Legend</b>  <span style="display: inline-block; width: 15px; height: 10px; background-color: #ADD8E6; border: 1px solid black; margin-right: 5px;"></span> Reconfigurable in User Mode</p> <p>Note:              (1) Core Clock can only be fed by dedicated clock input pins or PLL outputs.</p>
$R_L$	Receiver differential input discrete resistor (external to the Cyclone V device).
Sampling window (SW)	<p>Timing diagram—The period of time during which the data must be valid in order to capture it correctly. The setup and hold times determine the ideal strobe position in the sampling window, as shown:</p>  <p>The timing diagram shows a horizontal axis labeled 'Bit Time'. A double-headed arrow spans the width of the diagram. Below the axis, a sequence of five rectangular blocks is shown: '0.5 x TCCS', 'RSKM', 'Sampling Window (SW)', 'RSKM', and '0.5 x TCCS'. The 'Sampling Window (SW)' block is centered within the 'RSKM' blocks.</p>

continued...